WaveScalar: the Executive Summary

Dataflow machine

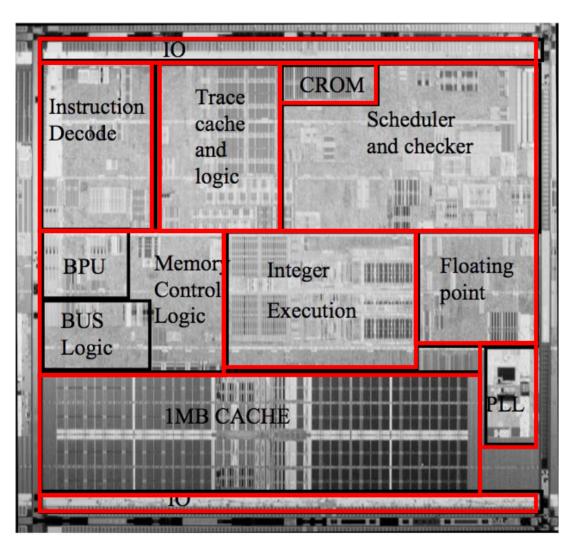
- good at exploiting ILP (dataflow parallelism)
- also traditional coarser-grain parallelism
 - cheap thread management
- low operand latency because of a hierarchical organization
- memory ordering enforced through wave-ordered memory
 - no special languages

WaveScalar

Additional motivation:

- increasing disparity between computation (fast transistors) & communication (long wires)
- increasing circuit complexity
- decreasing fabrication reliability

Monolithic von Neumann Processors



A phenomenal success today. But in 2016?

Performance
Centralized processing & control
Long wires
e.g., operand broadcast networks

⊗ Complexity 40-75% of "design" time is design verification

Oefect toleranceflaw -> paperweight

WaveScalar's Microarchitecture

Good performance via distributed microarchitecture ©

- hundreds of PEs
- organized hierarchically for fast communication between neighboring PEs
- short point-to-point (producer to consumer) operand communication
- dataflow execution no centralized control
- scalable

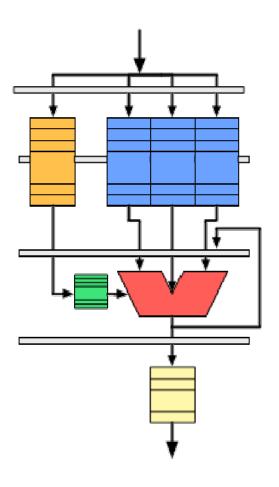
Low design complexity through simple, identical PEs ©

design one & stamp out thousands

Defect tolerance ©

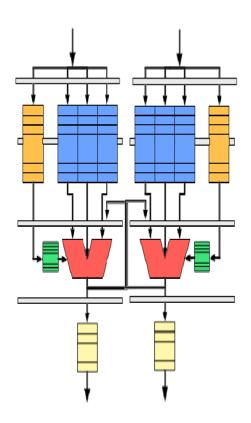
route around a bad PE

Processing Element



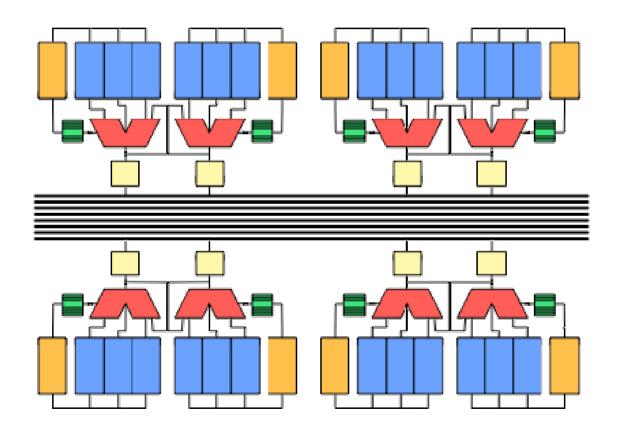
- Simple, small (.5M transistors)
- 5-stage pipeline (receive input operands, match tags, instruction issue, execute, send output)
- Holds 64 (decoded) instructions
- 128-entry token store
- 4-entry output buffer

PEs in a Pod

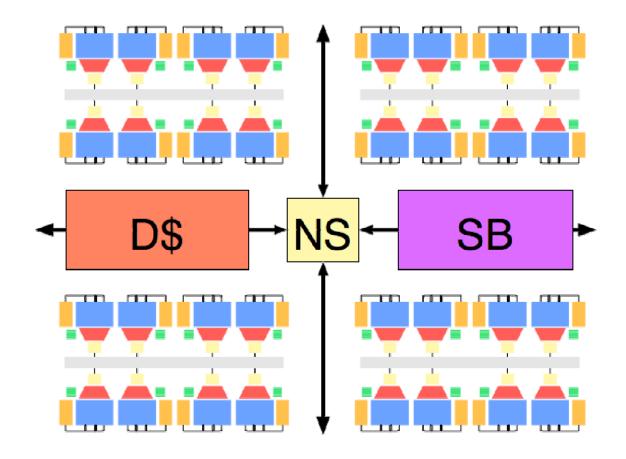


- Share operand bypass network
- Back-to-back producer-consumer execution across PEs
- Relieve congestion on intradomain bus

Domain



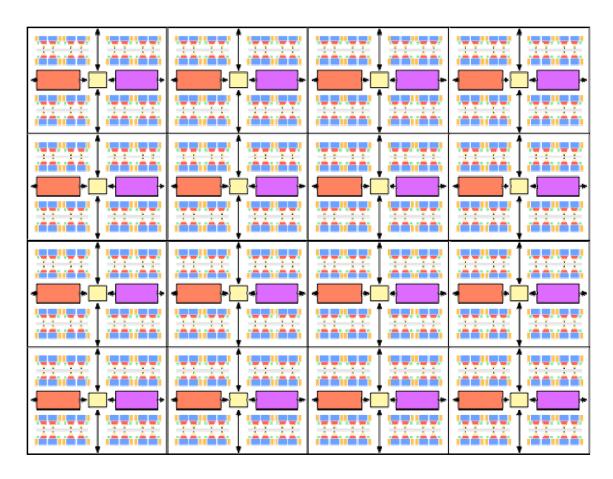
Cluster



WaveScalar Processor

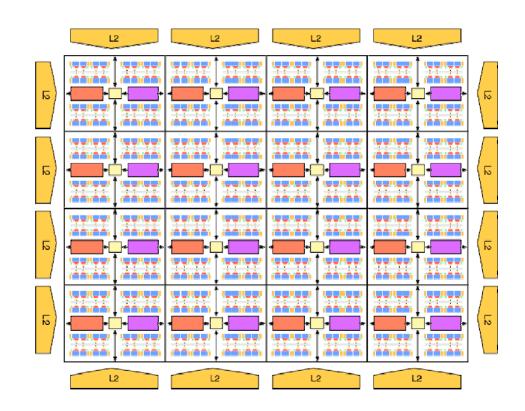
Long distance communication

- dynamic routing
- grid-based network
- 2-cycle hop/cluster

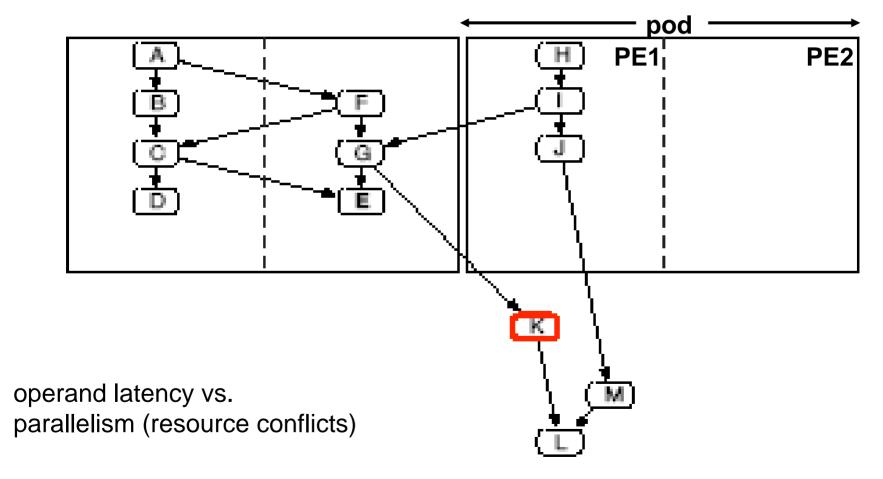


Whole Chip

- Can hold 32K instructions
- Normal memory hierarchy
- Traditional directory-based cache coherence
- ~400 mm² in 90 nm technology
- 1GHz.
- ~85 watts



WaveScalar Instruction Placement

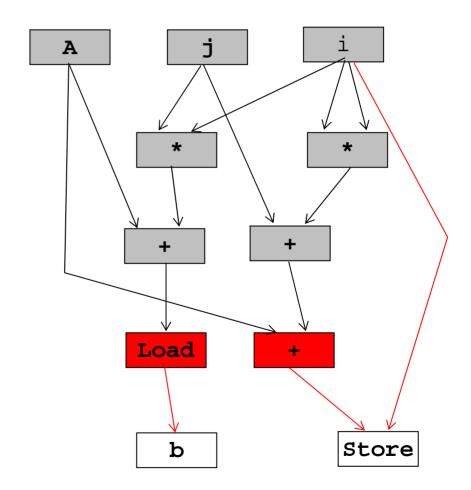


WaveScalar Instruction Placement

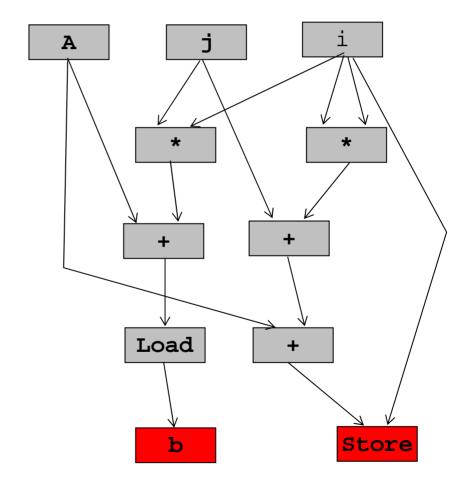
Place instructions in PEs to maximize data locality & instruction-level parallelism.

- Instruction placement algorithm based on a performance model that captures the important performance factors
- Carve the dataflow graph of instructions into segments
 - a particular depth to make chains of dependent instructions that will be placed in the same pod
 - a particular width to make multiple independent chains that will be placed in different, but near-by pods
 - called DAWG ('Deep and Wide Graph' Placement)
- Snakes segments across PES in the chip on demand
- K-loop bounding to prevent instruction "explosion"

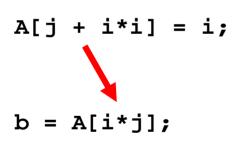
Example to Illustrate the Memory Ordering Problem

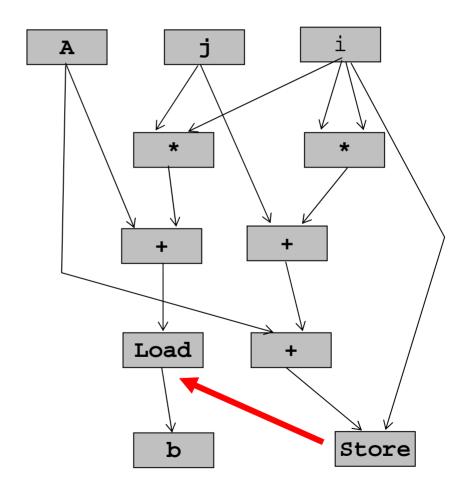


Example to Illustrate the Memory Ordering Problem

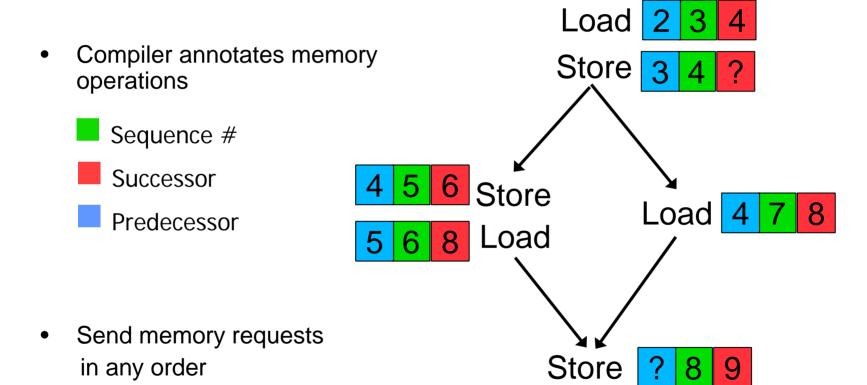


Example to Illustrate the Memory Ordering Problem



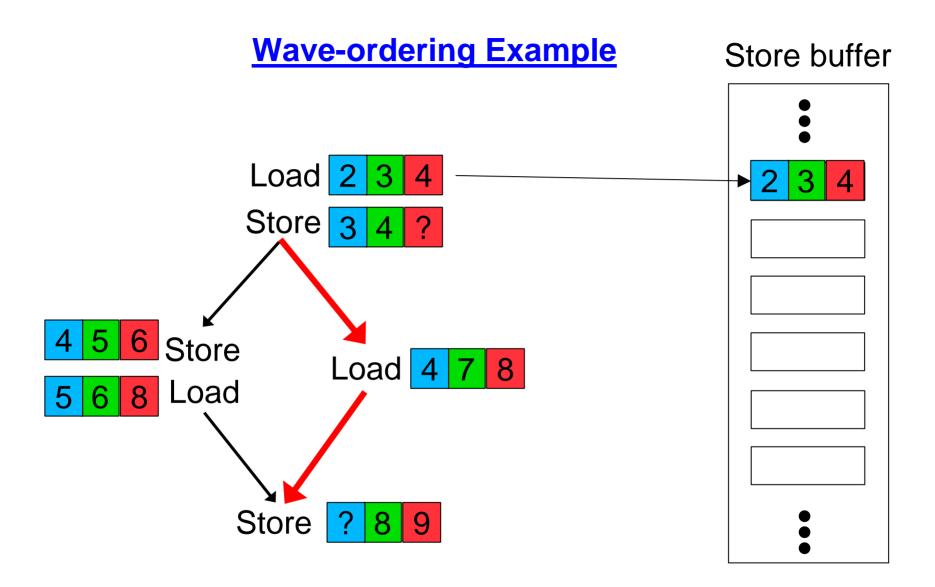


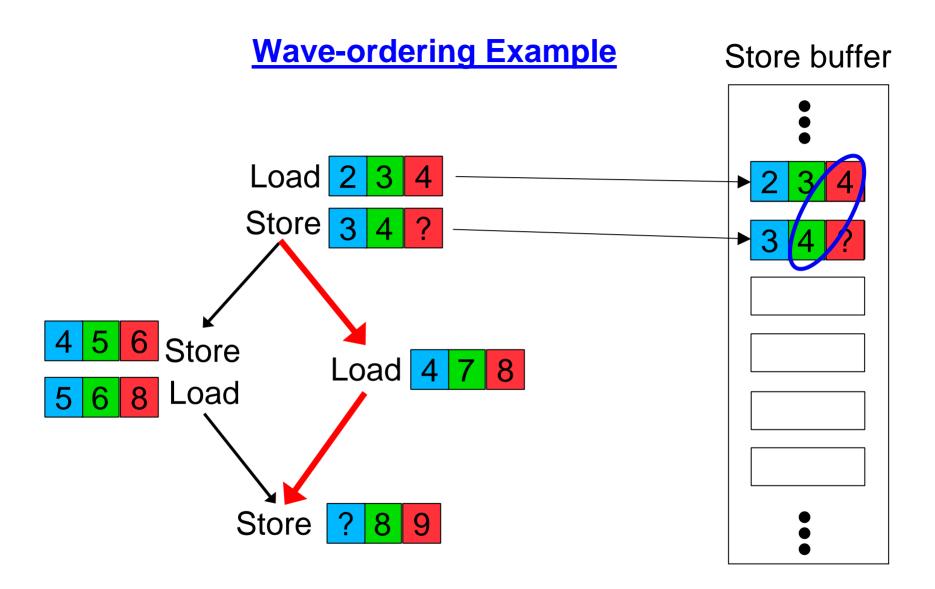
Wave-ordered Memory

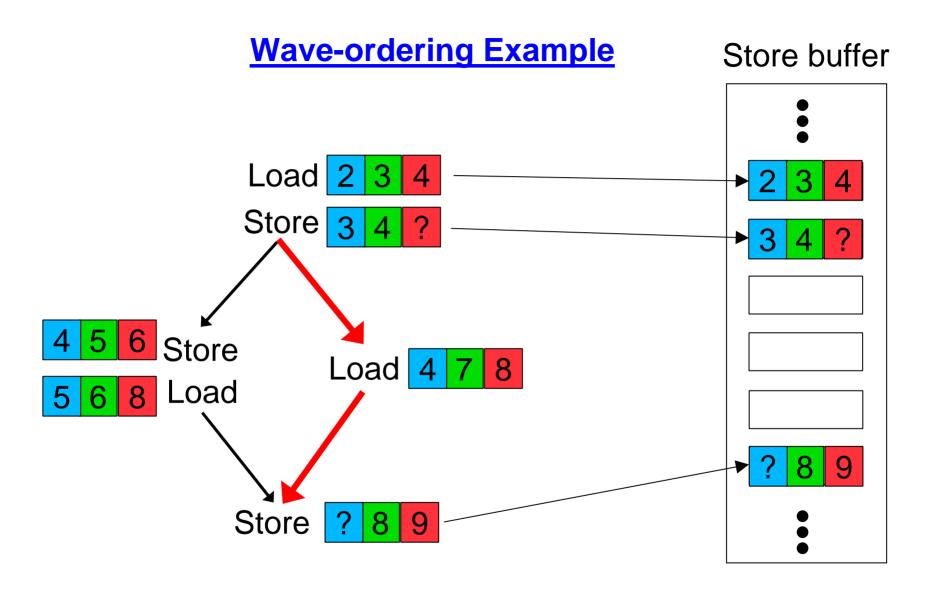


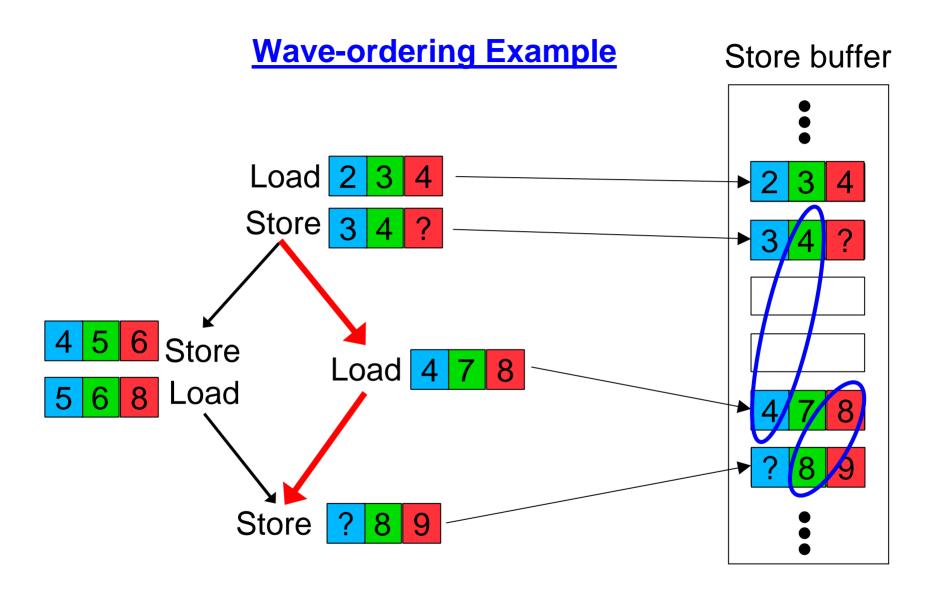
correct order

Hardware reconstructs the









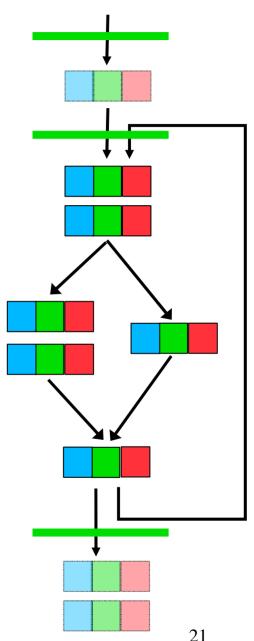
Wave-ordered Memory

Waves are loop-free sections of the dataflow graph

Each *dynamic* wave has a wave number Wave number is incremented between waves

Ordering memory in a whole program:

- wave-numbers
- sequence number within a wave



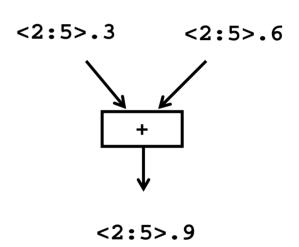
WaveScalar Tag-matching

WaveScalar tag

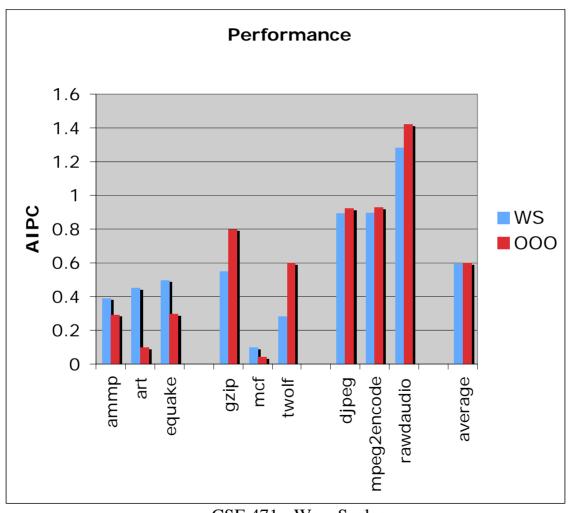
- thread identifier
- wave number

Token: tag & value





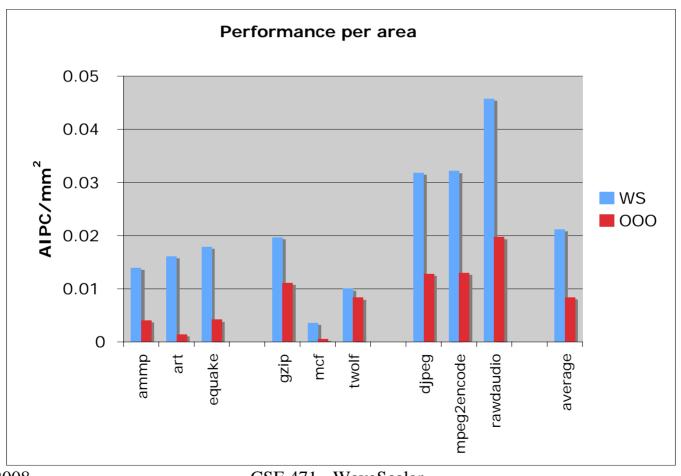
Single-thread Performance



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Single-thread Performance per Area



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Multithreading the WaveCache

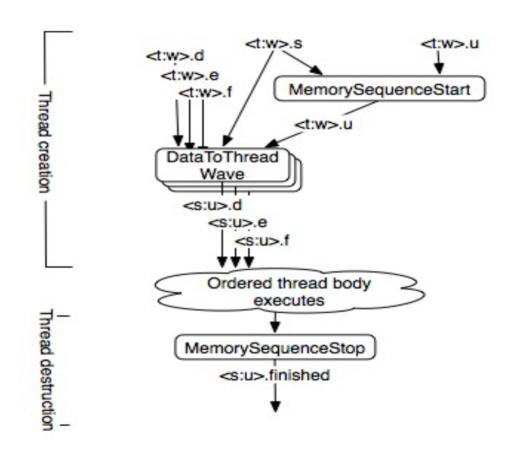
Architectural-support for WaveScalar threads

- instructions to start & stop memory orderings, i.e., threads
- memory-free synchronization to allow exclusive access to data (thread communicate instruction)
- fence instruction to force all previous memory operations to fully execute (to allow other threads to see the results of this one's memory ops)

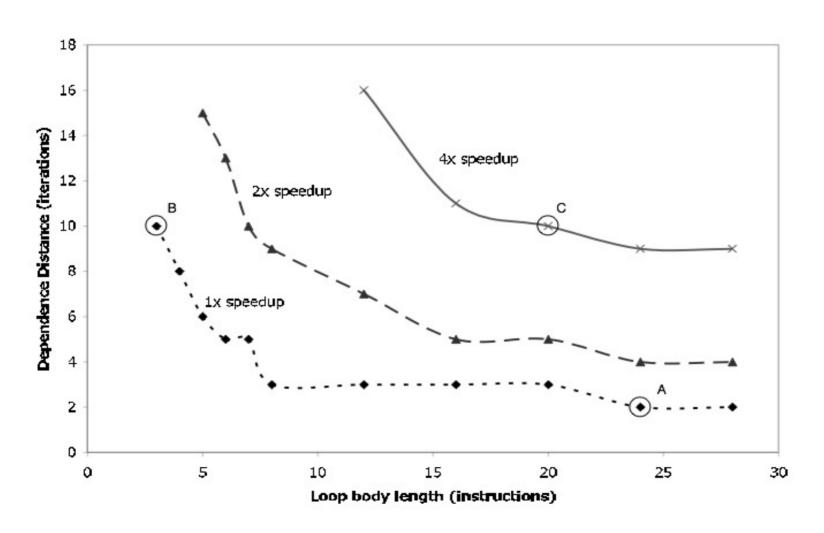
Combine to build threads with multiple granularities

- coarse-grain threads: 25-168X over a single thread; 2-16X over CMP, 5-11X over SMT
- fine-grain, dataflow-style threads: 18-242X over single thread
- a demonstration that one can combine the two in the same application (equake): 1.6X or 7.9X -> 9X

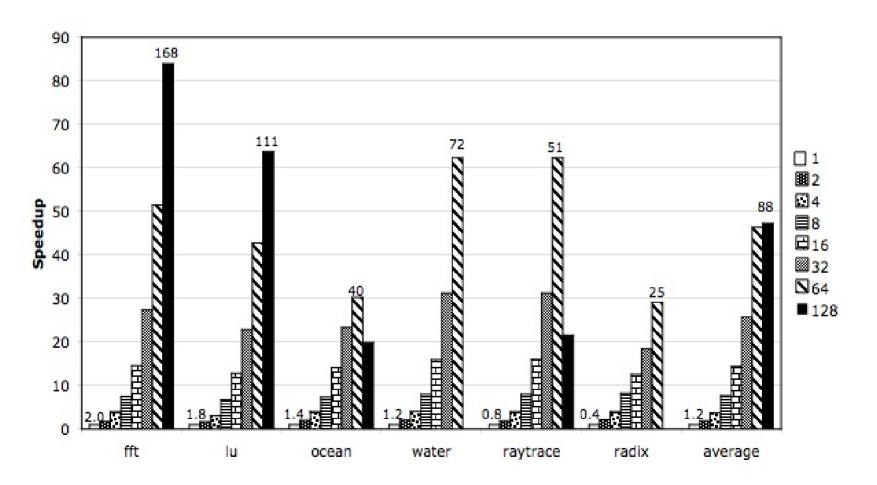
Creating & Terminating a Thread



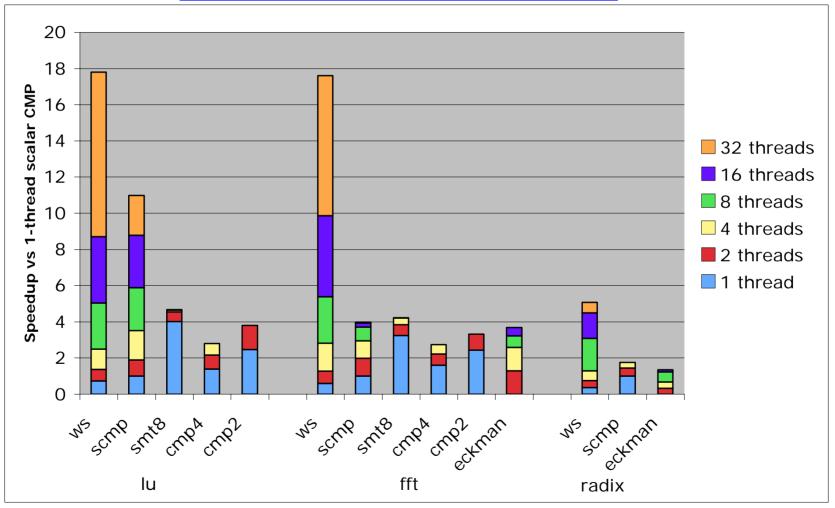
Thread Creation Overhead



Performance of Coarse-grain Parallelism

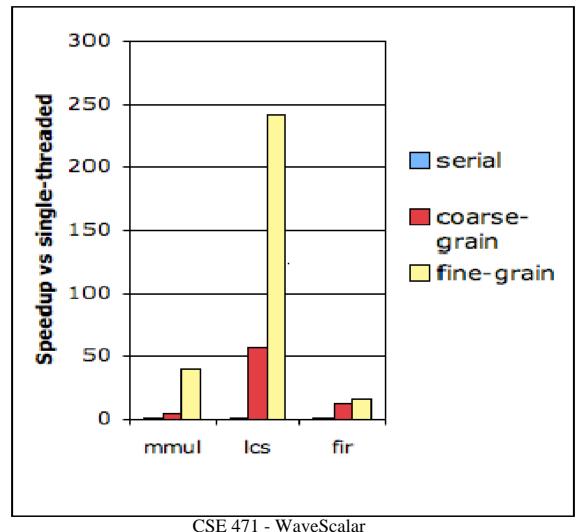


CMP & SMT Comparison



Relies on: Cheap synchronization Load once, pass data (not load/compute/store)

Performance of Fine-grain Parallelism



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Building the WaveCache

RTL-level implementation

- some didn't believe it could be built in a normal-sized chip
- some didn't believe it could achieve a decent cycle time and loaduse latencies
- Verilog & Synopsis CAD tools

Different WaveCache's for different applications

- 1 cluster: low-cost, low power, single-thread or embedded
 - 42 mm² in 90 nm process technology, 2.2 AIPC on Splash2
- 16 clusters: multiple threads, higher performance: 378 mm², 15.8
 AIPC

Board-level FPGA implementation

OS & real application simulations